

The standard product specification may change without	Revision
	Engineering
and product status before design for the standard product or	Date
release of the order.	

Our Reference

1.0

2018/01/4

REVISION RECORD

REV NO.	REV DATE	CONTENTS	REVISED PAGE NO.
1.0	2014-08-15	First Release	

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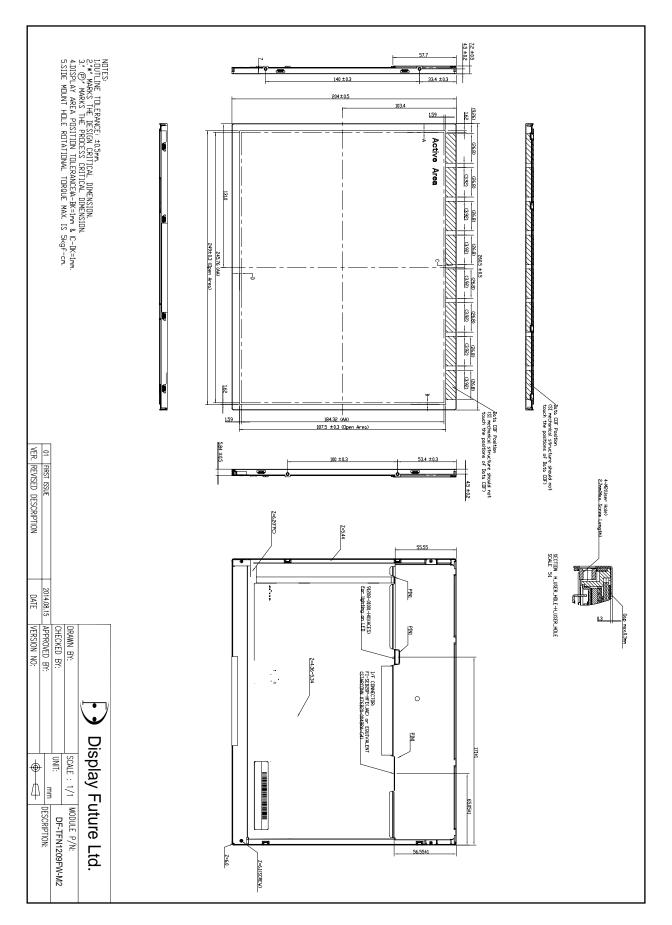
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■ GENERAL INFORMATION

Item	Contents	Unit
LCD type	TFT/Normally white	/
Size	12.1	Inch
Viewing direction	12:00(without image inversion and least brightness	O' Clock
	change)	
Gray scale inversion direction	6:00 (contrast peak located at)	O' Clock
$LCM(W \times H \times D)$	260.5×204.0×7.2	mm ³
Active area (W×H)	245.76×184.32	mm ²
Pixel pitch (W×H)	0.240×0.240	mm ²
Number of dots	1024 (RGB)× 768	/
Backlight type	LED	/
Interface type	LVDS	/
Color depth	262K/16.2M	/
Pixel configuration	R.G.B vertical stripe	/
Surface treatment	Hard coating(3H),AG	/
Module power consumption	6.6(Black pattern)	W
Input voltage	3.3/5.0	V
With/Without TSP	Without TSP	/
Weight	435	g

Note 1: RoHS compliant; Note 2: LCM weight tolerance: $\pm 5\%$.

EXTERNAL DIMENSIONS



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit	Note
Power supply voltage	VCC	-0.3	7.0	V	(1)
Converter voltage(backlight unit)	VI	-0.3	18	V	(1)(2)
Enable voltage	EN	-	5.5	V	
Backlight adjust	ADJ	-	5.5	V	
Operating temperature	Тор	-30	70	°C	(3)
Storage temperature	Tst	-40	80	°C	(3)

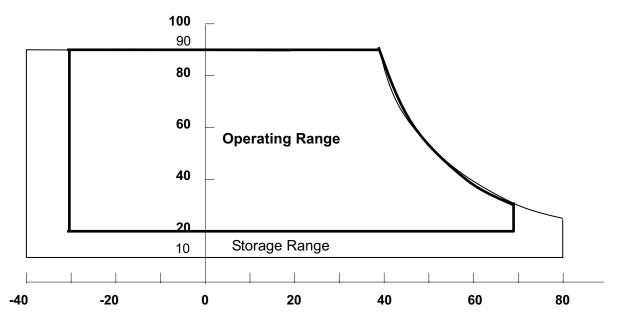
Note 1:Permanent damage to the device may occur if maximum values are exceeded.Function operation should be restricted to the conditions descrided under normal operating conditions.

Note 2:Specified values are for lamp(Refer to BACKLIGHT CHARACTERISTICS).

Note 3:(a) Temperature and relative humidity range is shown in the figure below.

- (b) 90%RH Max.(Ta \leq 40°C).
- (c) Wet-bulb temperature should be 39°C Max.(Ta>40°C).
- (d) No condensation.



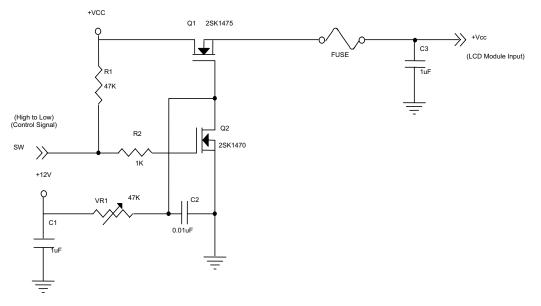


Temperature (°C)

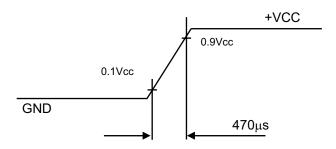
ELECTRICAL CHARACTERISTICS

Parameter		Symbol	Min	Тур	Max	Unit	Note
Power supply voltage		VCC	3.0	3.3	3.6	V	at VCC=3.3V
Tower suppry voltage		VCC	4.75	5.0	5.25	V	at VCC=5.0V
Rush current		IRUSH	-	-	4.0	A	(2)
	XX 71 · 4	-	-	410	490	mA	(3)a,at VCC=3.3V
Power supply current	White		-	320	395	mA	(3)a,at VCC=5.0V
i ower suppry current	Black	-	-	540	650	mA	(3)a,at VCC=3.3V
			-	400	480	mA	(3)a,at VCC=5.0V
Power consumption		PL	-	2.0	-	W	
LVDS differential input voltage		VID	100	-	600	mV	
LVDS common input voltage		VICM	0.7	-	1.6	V	

Note 1:The module is recommended to operate within specification ranges listed above for normal function. Note 2:Measurement conditions:



Vcc rising time is 470µs



Note 3:The specified power supply current is under the conditions at Vcc=3.3V or 5V,Ta=25±2°C,fv=60Hz, whereas a power dissipation check pattern below is displayed.

a. White Pattern

b. Black Pattern



Active Area



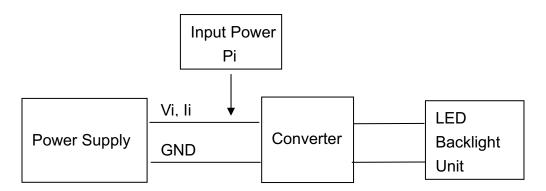
Active Area

■ BACKLIGHT CHARACTERISTICS

Item	Item		Min.	Тур.	Max.	Unit	Condition
Converter power	supply votage	Vi	7.0	12.0	17.0	V	
Converter power	supply current	Ii	-	0.4	0.5	А	@Vi=12V(Duty 100%)
LED power cons	umption	PLED	-	4.8	6.0	W	@Vi=12V(Duty 100%)
En control level	Backlight on	_	2.0	3.3	5.0	V	
	Backlight off	-	0	-	0.8	V	
PWM control	PWM high level	_	2.0	3.3	5.0	V	
level	PWM low level	-	0	-	0.15	V	
PWM control duty ratio		-	10	-	100	%	
PWM control frequency		Fpwm	190	200	210	Hz	
LED life time		Ll	30,000	-	-	Hrs	(2)

Note(1): LED current is measured by utilizing a high frequency current meter as shown below:

Note(2): The lifetime of LED is defined as the time when it continues to operate under the conditions at Ta=25±2°C and duty 100% until the brightness becomes≦50% of its original value. Operating LED at high temperature condition will reduce life time and lead to color shift.



Item	Item		Condition	Min	Тур	Max	Unit	Remark	Note
Response	Response time			-	16	26	ms	FIG 1.	4
Contrast r	atio	Cr	θ=0°	500	700	-		FIG 2.	1
Luminar uniform		δ WHITE	Ø=0° Ta=25℃	-	TBD	-	%	FIG 2.	3
Surface Lum	inance	Lv		400	500	-	cd/m ²	FIG 2.	2
			$\emptyset = 90^{\circ}$	60	70	-	deg	FIG 3.	
Viewing angl		0	$\emptyset = 270^{\circ}$	60	70	-	deg	FIG 3.	6
Viewing angl	le range	θ	$\emptyset = 0^{\circ}$	70	80	-	deg	FIG 3.	0
			$\emptyset = 180^{\circ}$	70	80	-	deg	FIG 3.	
	Red	Х		0.575	0.625	0.675			
	Red	у		0.308	0.358	0.408			
	Green	Х	θ=0°	0.274	0.324	0.374			
CIE (x, y)	Oreen	у	$\emptyset = 0^{\circ}$	0.554	0.604	0.654		FIG 2.	5
chromaticity	Blue	Х	2000 Ta=25℃	0.094	0.144	0.194		FIG 2.	5
	Diue	У	1a-23 C	0.038	0.088	0.138			
	White	Х		0.263	0.313	0.363			
	wille	у		0.279	0.329	0.379			

ELECTRO-OPTICAL CHARACTERISTICS

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.

Contrast Ratio = <u>Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)</u> Average Surface Luminance with all black pixels (P1, P2, P 3, P4, P5)

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

Note 3. The uniformity in surface luminance δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance. For more information see FIG 2.

δ WHITE =Minimum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)Maximum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

- Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series.
- Note 5. CIE (x, y) chromaticity, The x, y value is determined by measuring luminance at each test position 1 through 5, and then make average value.
- Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.
- Note 7. For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.

FIG. 1 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

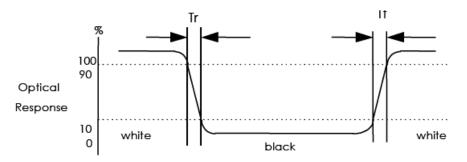
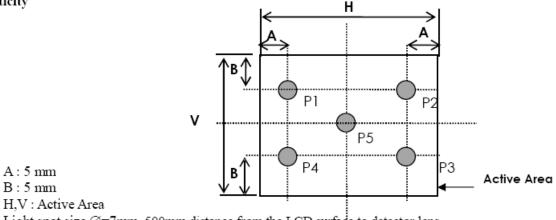
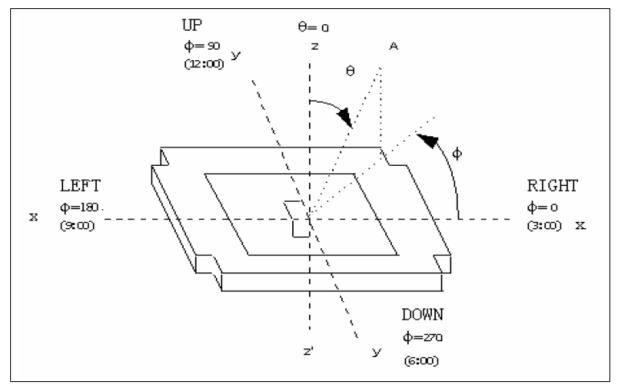


FIG. 2 Measuring method for Contrast ratio, surface luminance, Luminance uniformity , CIE (x, y) chromaticity



Light spot size \emptyset =7mm, 500mm distance from the LCD surfade to detector lens measurement instrument is TOPCON's luminance meter BM-5

FIG. 3 The definition of viewing angle



■ INTERFACE DESCRIPTION

1. TFT LCD MODULE

Pin	Name	Description	Remark
1	RX3+	Differential Data Input, CH3 (Positive)	
2	RX3-	Differential Data Input, CH3 (Negative)	
3	NC	NC	
4	SEL68	LVDS 6/8 bit select function control, Low or NC \rightarrow 6 bit Input Mode High \rightarrow 8bit Input Mode	Note (3)
5	GND	Ground	
6	RXC+	Differential Clock Input (Positive)	
7	RXC-	Differential Clock Input (Negative)	
8	GND	Ground	
9	RX2+	Differential Data Input, CH2 (Positive)	
10	RX2-	Differential Data Input, CH2 (Negative)	
11	GND	Ground	
12	RX1+	Differential Data Input, CH1 (Positive)	
13	RX1-	Differential Data Input, CH1 (Negative)	
14	GND	Ground	
15	RX0+	Differential Data Input, CH0 (Positive)	
16	RX0-	Differential Data Input, CH0 (Negative)	
17	Horizontal Reverse Scan Control,		Note (3)
18	reUD	Vertical Reverse Scan Control, Low or NC → Normal Mode, High → Vertical Reverse Scan	Note (3)
19	VCC	Power supply	
20	VCC	Power supply	

Note (1) Connector Part No.: STARCONN 076B20-0048RA-G4 or JAE FI-SEB20P-HFE or equivalent.

Note (2) User's connector Part No.: JAE FI-SE20ME or equivalent.

Note (3) "Low" stands for 0V. "High" stands for 3.3V. "NC" stands for "No Connected".

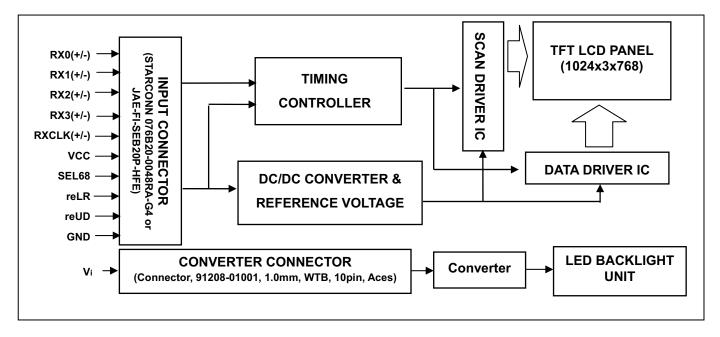
2. BACKLIGHT UNIT(COVERTER CONNECTOR PIN)

Pin	Symbol	Description	Remark
1	Vi	Converter input voltage	12V
2	Vi	Converter input voltage	12V
3	Vi	Converter input voltage	12V
4	Vi	Converter input voltage	12V
5	V_{GND}	Converter ground	Ground
6	V_{GND}	Converter ground	Ground
7	V_{GND}	Converter ground	Ground
8	V_{GND}	Converter ground	Ground
9	EN	Enable pin	3.3V
			PWM Dimming
10	ADJ	Backlight Adjust	(190-210Hz, Hi: 3.3V _{DC} ,
			Lo: 0V _{DC})

Note (1) Connector Part No.: 91208-01001-H01 (ACES) or equivalent.

Note (2) User's connector Part No.: 91209-01011 (ACES) or equivalent

BLOCK DIAGRAM



■ APPLICATION NOTES

1. Interface Timing

1.1 Input Signal Timing Specifications

The input signal timing specifications are shown as the following table and timing diagram.

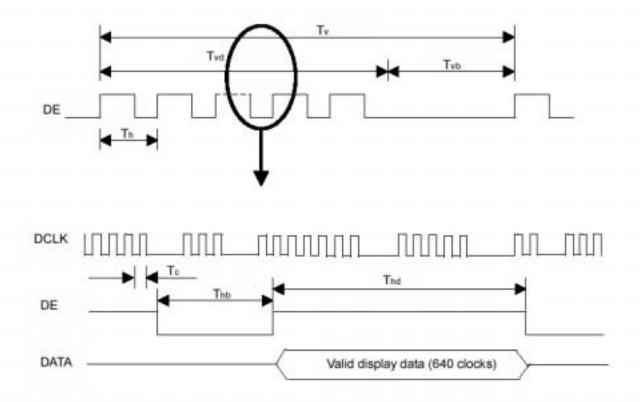
Signal	Item	Symbol	Min.	Тур.	Max.	Unit	Note
DCLK	Frequency	Fc	57.5	64.9	74.4	MHz	
	Total	Τv	774	806	848	Th	Tv=Tvd+Tvb
Vertical Active Display Term	Display	Tvd	-	768	-	Th	-
	Blank	Tvb	6	38	80	Th	-
	Total	Th	1240	1344	1464	Тс	Th=Thd+Thb
Horizontal Active Display Term	Display	Thd	-	1024	-	Тс	-
	Blank	Thb	216	320	440	Тс	-

Note (1) Since this assembly is operated in DE only mode, Hsync and Vsync input signals should be set to

low logic level. Otherwise, this assembly would operate abnormally.

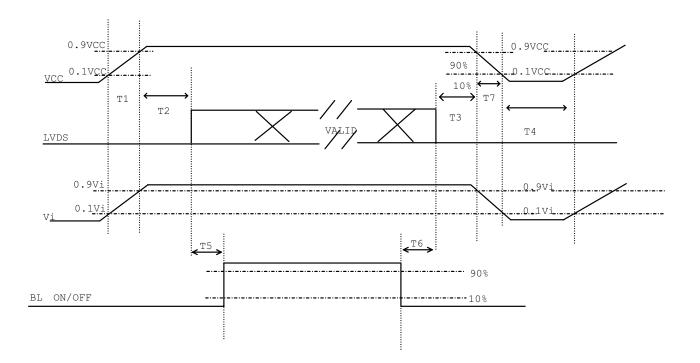
(2) Frame rate is 60Hz

INPUT SIGNAL TIMING DIAGRAM



1.2 Power On/Off Sequence

To prevent a latch-up or DC operation of LCD assembly, the power on/off sequence should be as the diagram below.

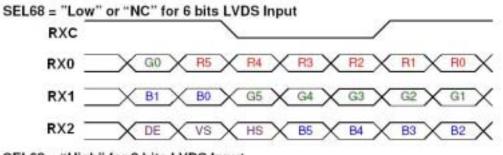


Power ON/OFF sequence

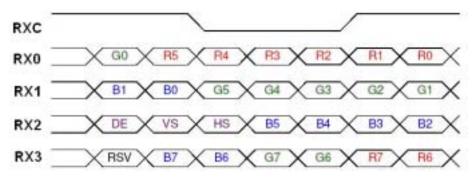
- Note (1) Please avoid floating state of interface signal at invalid period.
- Note (2) When the interface signal is invalid, be sure to pull down the power supply of LCD VCC to 0 V.
- Note (3) The Backlight converter power must be turned on after the power supply for the logic and the interface signal is valid. The Backlight converter power must be turned off before the power supply for the logic and the interface signal is invalid.

Parameter		Units		
Falametei	Min	Тур	Max	Units
T1	0.5	-	10	ms
T2	0	-	50	ms
Т3	0	-	50	ms
T4	500	-	-	ms
T5	200	-	-	ms
Т6	200	-	-	ms
Τ7	5	-	300	ms

1.3 The Input Data Format



SEL68 = "High" for 8 bits LVDS Input



Note (1) R/G/B data 7: MSB, R/G/B data 0: LSB

Note (2) Please follow PSWG

Signal Name	Description	Remark
R7	Red Data 7 (MSB)	Red-pixel Data
R6	Red Data 6	Each red pixel's brightness data consists of these
R5	Red Data 5	8 bits pixel data.
R4	Red Data 4	
R3	Red Data 3	
R2	Red Data 2	
R1	Red Data 1	
R0	Red Data 0 (LSB)	
G7	Green Data 7 (MSB)	Green-pixel Data
G6	GreenData 6	Each green pixel's brightness data consists of these
G5	GreenData 5	8 bits pixel data.
G4	GreenData 4	
G3	GreenData 3	
G2	GreenData 2	
G1	GreenData 1	
G0	GreenData 0 (LSB)	
B7	Blue Data 7 (MSB)	Blue-pixel Data
B6	Blue Data 6	Each blue pixel's brightness data consists of these
B5	Blue Data 5	8 bits pixel data.
B4	Blue Data 4	
B3	Blue Data 3	
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
RXCLKIN+	LVDS Clock Input	
RXCLKIN-		
DE	Display Enable	
VS	Vertical Sync	
HS	Horizontal Sync	

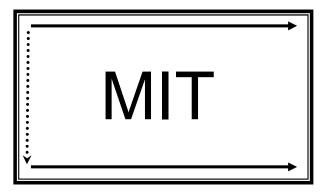
Note (3) Output signals from any system shall be low or Hi-Z state when VCC is off.

1.4 Scannig Direction

The following figures show the image see from the front view. The arrow indicates the direction of scan.

Fig.1 Normal Scan

Fig.2 Reverse Scan



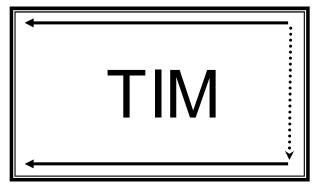


Fig.3 Reverse Scan

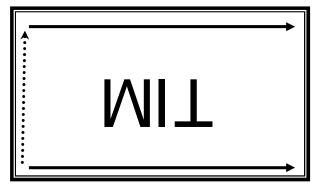
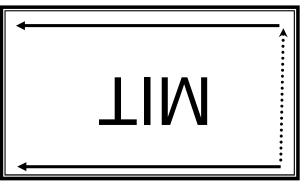


Fig.4 Reverse Scan



- Fig. 1 Normal scan (pin 17, reLR = Low or NC, pin 18, reUD = Low or NC)
- Fig. 2 Reverse scan (pin 17, reLR = High, pin 18, reUD = Low or NC)
- Fig. 3 Reverse scan (pin 17, reLR = Low or NC, pin 18, reUD = High)
- Fig. 4 Reverse scan (pin 17, reLR = High, pin 18, reUD = High)

2. Color Data Input Assignment

The brightness of each primary color (red, green and blue) is based on the 6-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of color versus data input.

								-	C)ata (Signa	al		-					
	Color			R						Gre							ue		
		R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Basic	Blue	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
Colors	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Red(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
Gray	Red(2)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Red	Red(61)	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(62)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
Gray	Green(2)	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Of	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
Green	Green(61)	0	0	0	0	0	0	1	1	1	1	0	1	0	0	0	0	0	0
	Green(62)	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
	Green(63)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Blue(0)/Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
Gray	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
Scale	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
Of	:				:	:	:		:	:	:	:		:	:	•	:		
Blue	Blue(61)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	0	1
	Blue(62)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
	Blue(63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

Note (1) 0: Low Level Voltage, 1: High Level Voltage

The brightness of each primary color (red, green and blue) is based on the 8-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of color versus data input.

		Data Signal																							
	Color				R	ed							G	reen							BI	ue			
			R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	B7	В6	В5	B4	В3	B2	B1	В0
Basic Colors	Black Red Green Blue Cyan Magenta Yellow White	0 1 0 0 1 1	0 1 0 0 1 1 1	0 1 0 0 1 1	0 1 0 0 1 1 1	0 1 0 0 1 1	0 1 0 0 1 1 1	0 1 0 0 1 1 1	0 1 0 0 1 1 1	0 0 1 0 1 0 1	0 1 0 1 0 1	0 0 1 0 1 0	0 0 1 0 1 1	0 0 1 0 1 0 1	0 0 1 0 1 1	0 0 1 0 1 1	0 0 1 0 1 0 1	0 0 1 1 0 1	0 0 1 1 1 0	0 0 1 1 1 0	0 0 1 1 1 0	0 0 1 1 1 0	0 0 1 1 1 0	0 0 1 1 0 1	0 0 1 1 1 0 1
Gray Scale Of Red	Red(0) / Dark Red(1) Red(2) : Red(253) Red(254) Red(255)	0 0 : 1 1	0 0 : 1 1	0 0 : 1 1	0 0 : 1 1	0 0 : 1 1	0 0 : 1 1	0 0 1 : 0 1	0 1 : : 1 0 1	0 0 : : 0 0	0 0 : : 0 0	0 0 0 0 0 0	0 0 : 0 0 0	0 0 : : 0 0	0 0 : 0 0	0 0 : 0 0 0	0 0 : : 0 0 0	0 0 : : 0 0	0 0 : : 0 0	0 0 : : 0 0	0 0 : : 0 0 0	0 0 : : 0 0	0 0 : : 0 0 0	0 0 : : 0 0	0 0 : : 0 0 0
Gray Scale Of Green	Green(0)/ Dark Green(1) Green(2) : Green(253) Green(254) Green(255)	0 0 : : 0 0	0 0 : : 0 0 0	0 0 : : 0 0 0	0 0 : : 0 0 0	0 0 : : 0 0	0 0 : : 0 0 0	0 0 : : 0 0 0	0 0 : : 0 0 0	0 0 : 1 1	0 0 : 1 1	0 0 : : 1 1	0 0 : 1 1	0 0 : 1 1	0 0 : 1 1	0 0 1 : 0 1	0 1 0 : 1 0 1	0 0 : : 0 0 0	0 0 : : 0 0 0	0 0 : : 0 0	0 0 : : 0 0 0	0 0 : : 0 0 0	0 0 : : 0 0 0	0 0 : : 0 0 0	0 0 : : 0 0 0
Gray Scale Of Blue	Blue(0) / Dark Blue(1) Blue(2) : Blue(253) Blue(254) Blue(255)	0 0 : : 0 0	0 0 : : 0 0	0 0 : : 0 0	0 0 : : 0 0	0 0 : : 0 0	0 0 : : 0 0	0 0 : : 0 0 0	0 0 : : 0 0 0	0 0 : : 0 0 0	0 0 : : 0 0	0 0 : : 0 0 0	0 0 : : 0 0	0 0 : : 0 0	0 0 : : 0 0	0 0 : : 0 0	0 0 : : 0 0	0 0 : 1 1	0 0 : 1 1	0 0 : 1 1	0 0 : 1 1	0 0 : 1 1	0 0 : 1 1	0 0 1 : 0 1	0 1 0 : 1 0 1

Note (1) 0: Low Level Voltage, 1: High Level Voltage

RELIABILITY TEST

Test Item	Test Condition	Note
High Temperature Storage Test	80°C, 240 hours	
Low Temperature Storage Test	-40°C, 240 hours	
Thermal Shock Storage Test	-30°C, 0.5hour ↔ 70°C, 0.5hour; 1hour/cycle,100cycles	
High Temperature Operation Test	70°C, 240 hours	(1)(2)
Low Temperature Operation Test	-30°C, 240 hours	
High Temperature & High Humidity Operation Test	60°C, 90%RH, 240hours	
Shock (Non-Operating)	200G, 2ms, half sine wave, 1 time for ± X, ± Y, ± Z.	(3)
Vibration (Non-Operating)	1.5G, 10 ~ 300 Hz, 10min/cycle, 3 cycles each X, Y, Z	(3)

Note (1) There should be no condensation on the surface of panel during test.

Note (2) Temperature of panel display surface area should be 80 °C Max.

- Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.
- Note (4) In the standard conditions, there is no function failure issue occurred. All the cosmetic specifications are judged before reliability test.

■ INSPECTION CRITERION

INSI ECTION CRITERION	
OUTGOING QUALITY STANDARD	PAGE 1 OF 5
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	
This specification is made to be used as the standard accep	tance/rejection criteria for TFT module.
1 Sample plan	
1.1 Lot size: Quantity per shipment lot per model	
1.2 Sampling type: Normal inspection, Single sampling	
1.3 Inspection level: II	
1.4 Sampling table: MIL-STD-105D	
1.5 Acceptable quality level (AQL)	
Major defect: AQL=0.65	
Minor defect: AQL=1.50 2. Inspection condition	
2.1 Ambient conditions:	
a. Temperature: Room temperature $25\pm 5^{\circ}$ C	
b. Humidity: (60 ± 10) %RH	
c. Illumination: Single fluoresœnt lamp non-directive	(300 to 700 Lux)
2.2 Viewing distance:	(200 to 700 Lait)
The distance between the LCD and the inspector's eye	es shall be at least $35\pm$ 5cm.
2.3 Viewing Angle	
U/D: 45° /45° , L/R: 45° /45°	
Eve position	1
45° 45° 35cm~40cm 90° LCD Panel	
3. Definition of Inspection Item.	_
3.1 Definition of inspection zone in LCD.	
A B C	
Zone A: character/Digit area	
Zone B: viewing area except Zone A (ZoneA+ZoneB=	minimum Viewing area)
Zone C: Outside viewing area (invisible area after asser	- · ·
Fig.1 Inspection zones in an LCD.	- 1 7
0r	

OUTGOING QUALITY STANDARD	PAGE 2 OF 5
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TITLE: FUNCTIONAL TEST & INSPECTION CRITERIA

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

4. Inspection standards

Defects are classified as majot defects and minor defects according to the degree of defectiveness defined herein.

4.1 Major defect

Item No	Items to be inspected	Inspection Standard
4.1.1	All functional defects	 No display Display abnormally Short circuit Line defect Excess power consumption
4.1.2	Missing	Missing function component
4.1.3	Crack	Glass crack

4.2 Minor defect

Item No	Items to be inspected	Inspection standard			
4.2.1	Spot Defect Including Black spot	For dark/white spot is define $\varphi = (\mathbf{x} + \mathbf{y}) / 2$ $\mathbf{x} \leftarrow \mathbf{y}$ $\mathbf{x} \leftarrow \mathbf{y}$ \mathbf{y}	ined		
	White spot Pinhole Foreign particle	Size φ(mm) φ≤0.15 2mm(min) apart	Acceptable Quantity Ignore		
	Polarizer dirt	0.15 < φ≤ 0.25 5mm(min) apart	3		
		0.25<φ	Not allowed		

	OUTGOIN	IG QUALITY STANDARD	PAGE 3 OF 5
ΓLE:FUN	CTIONAL TEST & I		
		Define:	
		Length V	Vidth
4.2.2	Line Defect Including Black line	Width(mm) Length(mm)	Acceptable Quantity
	White line	W≤0.05 and L≤10	Ignore
	Scratch	0.05 < W≤0.08 and L≤10 3mm(min) apart	3
		0.08 < W≤0.10 andL≤5 3mm(min) apart	1
		0.10< W or 10 <l< td=""><td>Not allowed</td></l<>	Not allowed
		Size $\varphi(mm)$	Acceptable Quantity
	Polarizer	φ ≤0.25	Ignore
4.2.3	Dent/Bubble	Non visible area	Ignore
		0.25<φ≤0.40 5mm(min) apart	2
		0.40< φ	Not allowed
		Bright and Black dot defi	ne:
4.2.4	Electrical Dot Defect	Inspection pattern: Full and blue screens	white, Full black, Red, green
		Item	Acceptable Quantity
		Black dot defect	2
		Bright dot defect	0
		Total Dot	2

	OUTGOIN	PAGE 4 OF 5					
TITLE:FUN	CTIONAL TEST & I						
		1.Corner chips:	X X Y				
		Size(mm)	Acceptable Quantity				
4.2.5	Touch panel chips	X≤3mm Y≤3mm Z≤T	Ignore T: Glass thickness X: Length Y: Width Z: thickness				
		2. Side chips:	Y Z				
		Size(mm)	Acceptable Quantity				
		X≤5mm Y ≤3mm Z≤T	Ignore T: Glass thickness X: Length Y: Width Z: thickness				

ispiay	rului e Llu	DF-TFN1209FW-M2 ver
	OUTGOING QUALITY STANDARD	PAGE 5 OF 5
TLE:FUN	CTIONAL TEST & INSPECTION CRITERIA	
ITLE:FUN Note:		or black and bright dot defects distance between two bright dot appears on active display area. The ed if the polarizer bubble appears on

PRECAUTIONS FOR USING LCD MODULES

Handing Precautions

(1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.

(2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.

(3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).

(4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.

(5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents

- Isopropyl alcohol

- Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

(6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.

- Water

- Ketone
- Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

(7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.

(8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.

(9) Do not attempt to disassemble or process the LCD module.

(10) NC terminal should be open. Do not connect anything.

(11) If the logic circuit power is off, do not apply the input signals.

(12) Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.

- Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated

(13) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.

- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

- Do not damage or modify the pattern writing on the printed circuit board.

- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.

- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

- Do not drop, bend or twist LCM.

Handling precaution for LCM

LCM is easy to be damaged. Please note below and be careful for handling!

Correct handling:



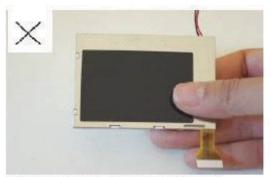


As above picture, please handle with anti-static gloves around LCM edges.

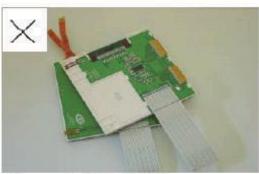
Incorrect handling:



Please don't touch IC directly.



Please don't hold the surface of panel.



Please don't stack LCM.



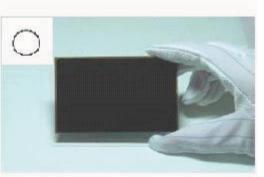
Please don't stretch interface of output, such as FPC cable.

Handling precaution for LCD

LCD is easy to be damaged. Please note below and be careful for handling!

Correct handling:





As above photo, please handle with anti-static gloves around LCD edges.

Incorrect handling:



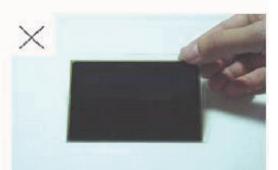
Please don't stack the LCDS.



Please don't hold the surface of LCD.



Please don't operate with sharp stick such as pens.



Please don't touch ITO glass without anti-static gloves.

Storage Precautions

When storing the LCD modules, the following precaution is necessary.

(1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.

(2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.

(3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the anti-static electricity container in which they were shipped. Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.

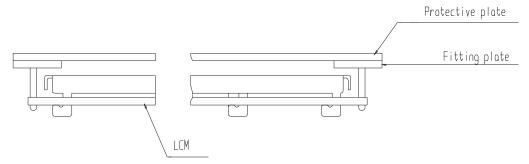
-Terminal electrode sections.

USING LCD MODULES

Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

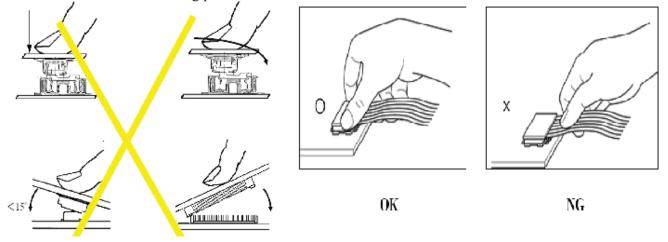
(1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



(2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.

Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows



Precaution for soldering to the LCM

	Hand soldering	Machine drag soldering	Machine press soldering
No ROHS	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
product	Time : 3-5S.	Speed : 4-8 mm/s.	Time : 3-6S.
product			Press: 0.8~1.2Mpa
ROHS	340°C ∼370°C.	350°C ~370°C.	330°C ~360°C.
product	Time : 3-5S.	Time : 4-8 mm/s.	Time : 3-6S.
product			Press: 0.8~1.2Mpa

(1) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

(2) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.

(3) When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

Precautions for Operation

(1) Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.

(2) It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.

(3) Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, Which will come back in the specified operating temperature.

(4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.

(5) A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature,50%RH or less is required.

(6) Input each signal after the positive/negative voltage becomes stable.

(7) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

Safety

(1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.

(2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

Safety

(1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.

(2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

Limited Warranty

Unless agreed otherwise between Display Future Ltd and customer, Display Future will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned within 90 days of the shipment. Confirmation of such date shall be based on data code on the product.

The warranty liability of Display Future limited to repair and/or replacement on the terms set forth above. Display Future will not be responsible for any subsequent or consequential events.

Return LCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- PCB eyelet is damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- Soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

PRIOR CONSULT MATTER

1. (1) For Display Future standard products, we keep the right to change material and processes for improving the product, without notice to our customers.

⁽²⁾For OEM products, if any change is needed, which may affect the product property, we will consult with our customer in advance.

2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.

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